

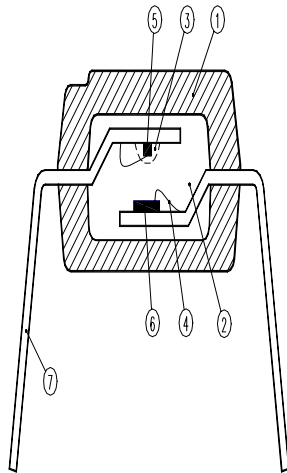
Product Material Element Sheet (產品物質元素表)

Manufacturer : Isocom

Component Name TLP521

Date : 4-Jul-2012

Weight List	
Weight (mg)	225.662

Product Material Sheet									
Construction Diagram (拆解圖示)	Item	Component (填寫拆解部品)	Component mass (拆解部品重量) (mg)	Element name (填寫 元素名稱)	CAS Number (元素化學編號)	Amount of Element (元素重量) (mg)	Element Percentage (元素百分比) (%)	ppm (mg/kg)	ICP
	1	Black compound	85.0176	Epoxy Compound	25068-38-6	85.0176	37.675%	37674.7525	Intertek BKKH08000309
	2	White compound	61.563	Epoxy Compound	25068-38-6	61.563	27.281%	27281.0664	Intertek BKKH08000311
	3	Silicon epoxy	1	Silicon	7440-21-3	1	0.443%	443.1406	SGS CE/2007/B3841
	4	Gold wire	0.0515	Au	7440-57-5	0.0515	0.023%	22.8217	SGS KA/2007/C1838
	5	Infrared dice	0.0333	GaAs	1303-00-0	0.0333	0.015%	14.7566	SGS CE/2008/23877
	6	Phototransister dice	0.0666	Silicon	7440-21-3	0.0666	0.030%	29.5132	SGS CE/2008/23853
	7	L/F	77.5	Fe	7439-89-6	77.5	34.343%	34343.3985	SGS SH8059265/CHEM
	8	Silver epoxy	0.168	Ag	7440-22-4	0.168	0.074%	74.4476	Intertek THJ0059678
	9	Plating	0.262	Sn	7440-31-5	0.262	0.116%	116.1028	SGS 1349842
		SUM	225.662			225.662	100.000%	100000	

(包材) Material of packing	
Component	Material name
Inner Plastic Bag (box)	Paper
Exterior Carton	Paper
Labels	Paper
Seal	Plastic